

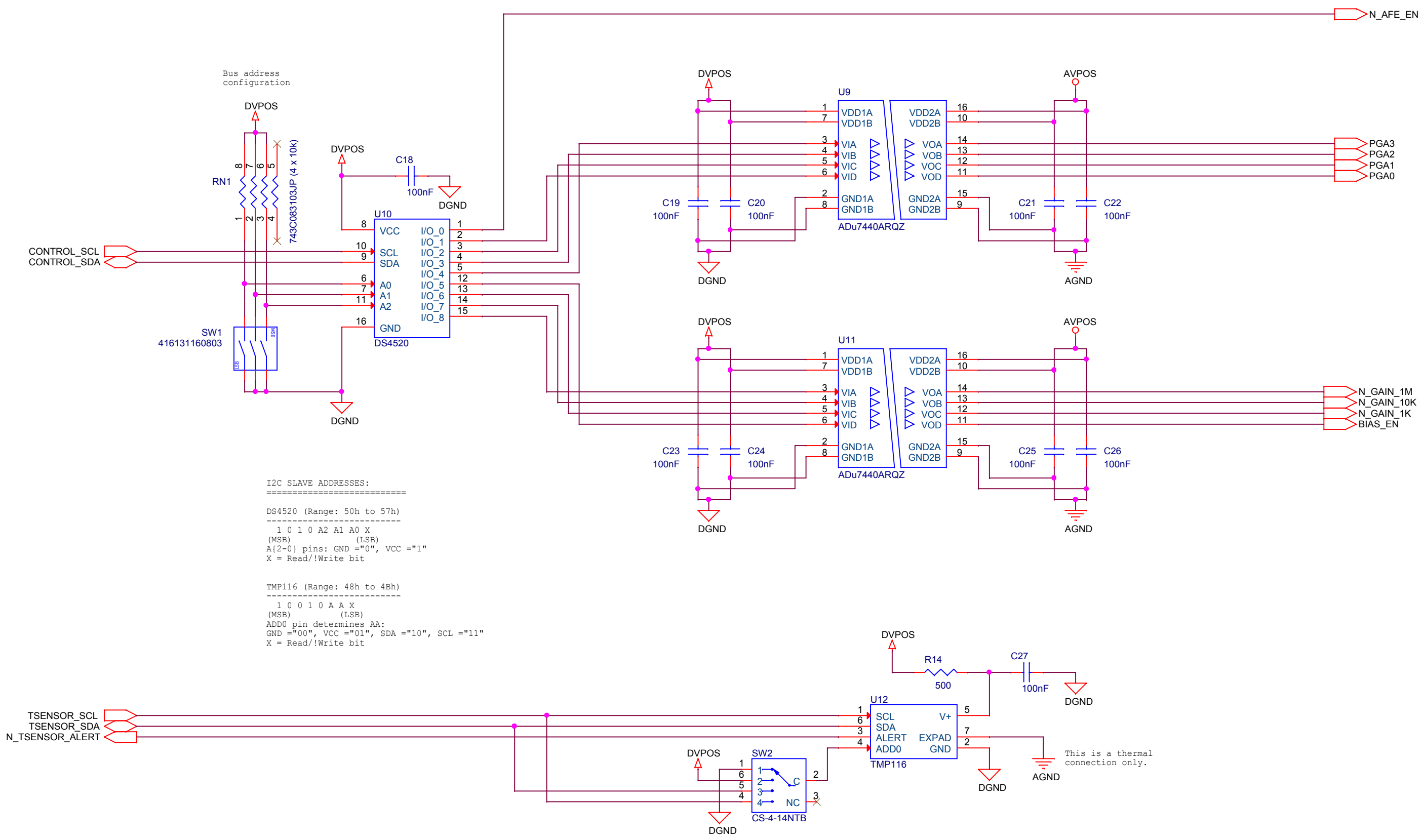
ASSEMBLY NOTES:

- * Use solder paste containing RMA flux. Do not use no-clean or water-soluble types.
- * Wash board for 15min in clean IPA & hexanes, then bake for 1.5hours at 125 deg. C. (for RMA flux)
- * Populate address-selection switches AFTER board washing; they may not stand up to vigorous washing; consider them splash-proof, but nothing more.
- * Populate J3 for triaxial/3-pin photodiodes or J4 for coaxial/2-pin photodiodes.
- * To CONNECT the bias circuit, populate R19 & R21 and remove R20. Use the reverse configuration to run without the bias circuit.
- * Install shields after washing.
- * Populate/Omit I2C pull-ups and their values according to system bus capacitance and speed.
- * Battery & I/O connectors' shroud mating face must be <= 5.5mm from board edge.

Mounting Holes (Clearance)
For use with plastic 21mm M3 standoffs
(Essentra Components' CBMFTS310A)



Andrew Macdonald - UVic Physics & Astronomy, 2018		
Title Photodiode Analog Frontend - ALTAIR Project		
DRAFT - NOT RELEASED		
Size B	Document Number <Doc>	Rev A
Date: Friday, November 02, 2018	Sheet 1	of 3



I2C SLAVE ADDRESSES:
 =====
 DS4520 (Range: 50h to 57h)

 1 0 1 0 A2 A1 A0 X
 (MSB) (LSB)
 A{2-0} pins: GND = "0", VCC = "1"
 X = Read/!Write bit

TMP116 (Range: 48h to 4Bh)

 1 0 0 1 0 A A X
 (MSB) (LSB)
 ADD0 pin determines AA:
 GND = "00", VCC = "01", SDA = "10", SCL = "11"
 X = Read/!Write bit

I2C Temperature Sensor:
 * Useful if PD measurements are found to require temperature-compensation.
 * Placed in good thermal contact with analog ground plane for monitoring board temperature.

This is a thermal connection only.

Title			Photodiode Analog Frontend - ALTAIR Project		
			DRAFT - NOT RELEASED		
Size	Document Number				Rev
B	<Doc>				<RevCode>
Date:	Thursday, November 08, 2018	Sheet	3	of	3